

Blocking temperature engineering in exchange-biased CoFeB/IrMn bilayer

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In this paper we report on the magnetic and chemical characterization of the exchange-biased CoFeB/IrMn bilayers, grown by magnetron sputtering on a Si-based platform and capped by either a Ru or MgO/Ru overlayer. For Ru capping, the blocking temperature monotonously increases with the IrMn thickness within the investigated range (3.5 – 8 nm). On the contrary, for MgO/Ru capping, the exchange bias is inhibited below 6 nm, whereas above 6 nm the magnetic behavior is the same of Ru-capped films. The chemical analysis reveals a significant dependence of the Mn content from the capping layer for thin IrMn films (2.5 nm), whereas the difference disappears when IrMn becomes thick (7 nm). Our work suggests that a non-uniform composition of the IrMn films directly affects the exchange coupling at the IrMn/CoFeB interface.

Index Terms— Magnetic and Spintronic Materials, Antiferromagnetic layer, Exchange coupling, Magnetic multilayers.

I. INTRODUCTION

The constant need for improving the data storage and manipulation capability of devices is one of the biggest challenges for the research and industry world, which is approaching the limits of Moore's law. Spintronic devices based on ferromagnets (FM), such as modern hard drives or magnetic random access memories (MRAMs), represented a significant improvement in the electronics history [1]. However, the scalability and speed of spintronic devices based on ferromagnetic elements is currently limited by several factors, such as the presence of cross-talk between the layers due to stray fields, the power dissipated during writing and the typical precession frequencies of the ferromagnets in the GHz range [2]. Antiferromagnetic (AFM) materials are promising candidates for ultrascaled and ultrafast spintronic devices: AFMs do not produce stray magnetic fields, are robust against external unintended magnetic fields and have typical precession frequencies in the THz range [3]-[5]. Different approaches for storing and reading information in the spin configuration of an AFM layer have been explored. Storing can be achieved by exchange spring with a FM layer [3],[6], field-cooling [7], strain [8], current-induced torques [9] or mechanisms based on the spin Hall Effect [10], whereas reading typically exploits anisotropic magneto-resistance (AMR) effects in thin films [11] or vertical devices comprising a tunnel barrier [3],[7],[12]. Different conducting materials have been investigated for AFM spintronics applications: for example IrMn, FeRh [11], Mn₂Au [13],[14], CuMnAs [15], Sr₂IrO₄ [16], and Cr [17],[18]. Among them, IrMn has long been used as a pinning layer in spintronic devices (GMR, TMR) [19], presents a non-collinear (3Q) spin structure [20] and its AFM phases cover a quite large stoichiometric range [21] in polycrystalline films, at variance with other compounds (e.g., Mn₂Au and CuMnAs) that need a fine tuning of the stoichiometric ratios and very good crystallinity for stabilizing the AFM phase.

Since the observation of tunneling anisotropic magnetoresistance (TAMR) in IrMn/MgO bilayers [7],[22],

this antiferromagnet has become an active element for AFM spintronics [9],[23],[24],[25]. For these applications, it is fundamental to understand if the proximity of the MgO tunneling barrier can alter somehow the structural, chemical or magnetic properties of the thin IrMn film, while trying to act on the IrMn thickness to bring the functionality of the devices towards room temperature (RT). This reason constitutes one driving force of this work.

Another emerging application of IrMn [26] employs IrMn as a platform for creating reconfigurable magnetic landscapes, exploiting local field-cooling performed by an atomic force microscope on a CoFeB/IrMn bilayer. This technique opens the route to the development of novel metamaterials with finely tuned magnetic properties, such as reconfigurable magneto-plasmonic and magnonic structures.

For all the applications relying on exchange-biased systems, a control of the blocking temperature is needed. It has to lie above room temperature, but below the maximum temperature that the material can reach in the proximity of the AFM tip. Moreover, the exchange bias at room temperature must be larger than the coercive field.

The dependence of the critical temperature versus the IrMn thickness has been intensively studied in the last decades ([27] and references therein) on several exchange-biased FM/IrMn systems (see, e.g., [26], [28], [29] for Co, CoFe, and NiFe, respectively, playing the role of the FM). The IrMn/CoFeB system has already been considered, even if the different heterostructure details and stoichiometry prevent from a strict comparison between the results. In [30], e.g., are reported the exchange bias and coercivity behavior of an IrMn/CoFeB system, with the magnetic layer Fe-rich (the stoichiometry is Co_{0.2}Fe_{0.6}B_{0.2}) and directly grown on Si. A positive loop shift due to exchange bias is shown, as typically happens in exchange-biased spin valves. A similar behavior has been reported in [31], where IrMn/CoFeB is grown on a CoFe seed layer resulting in a positive exchange-bias even in absence of field-cooling. In some cases, both positive and negative exchange bias coexist [32]. All this variety of possibilities can be ascribed to the polycrystalline nature of IrMn, that makes

interface (the disordered interface spin structure exhibiting spin-glass-behaviour) and film (the AF grains which undergo thermally activated magnetic reversal) crucial in determining the magnetic properties [33]. The effects of interface composition and stoichiometry on different FM/AFM systems have been addressed too (see, e.g., [34] and [35]).

Here we focus on the CoFeB/IrMn bilayer, and we report on its exchange bias properties and critical temperatures versus IrMn thickness and having IrMn in contact with different capping layers (Ru and MgO/Ru). This work can allow the design of stacks based on this combination of materials suitable for specific applications (e.g. tam-SPL [26] and TAMR [7],[22]) requiring a careful engineering of exchange-bias.

FIG. 1 HERE

II. EXPERIMENTAL

The heterostructures were grown by magnetron sputtering (AJA ATC Orion 8) on Si(001)/native-SiO₂ and Si(001)/thermal-SiO₂(1 μm) substrates. In the former, the thin native oxide layer (~2 nm) is due to the exposure to the air. A magnetic field of 24 kA/m was applied along Si [100] during the deposition. The stack was

Ta(5)/Ru(18)/Ta(3)/CoFeB(3)/IrMn(t_{IrMn})/MgO(t_{MgO})/Ru(t_{Ru}) (layer thicknesses in nm), as shown in Fig. 1(a). Metals were grown in dc mode, whereas MgO was deposited in rf mode. The nominal stoichiometries of CoFeB and IrMn targets were Co_{0.4}Fe_{0.4}B_{0.2} and Ir_{0.22}Mn_{0.78} (in the paper, for sake of simplicity we will call them CoFeB and IrMn, respectively, without specifying the elemental composition). The Ta(5)/Ru(18)/Ta(3) buffer layer was used to avoid CoFeB intermixing with the substrate, to improve its crystallization [36] and the [111] texture of IrMn, which determines the exchange bias with CoFeB [37]. The IrMn thickness (t_{IrMn}) was varied between 3.5 and 8 nm to investigate its influence on the IrMn blocking temperature. We also studied the impact of an MgO interlayer, with thickness compatible with TAMR applications [7],[22] ($t_{\text{MgO}} = 2.5$ nm), between IrMn and Ru.

The chemical properties have been investigated in ultra-high vacuum conditions by X-ray Photoemission Spectroscopy (XPS), employing standard unpolarized Al-K_α and Mg-K_α X-ray sources and collecting photoelectrons by an Hemispherical Energy Analyzer Phoibos 150 (SPECSTM). In samples for XPS the Ru capping layer was thin enough ($t_{\text{Ru}} = 2$ nm) to allow for detection of photoelectrons coming out from IrMn.

The magnetic characterization has been performed by a commercial Vibrating Sample Magnetometer (VSM MicroSense EZ9) on samples with thick Ru capping layer ($t_{\text{Ru}} = 20$ nm) to ensure protection from contamination upon air exposure. The VSM allows for temperature measurements with the sample kept within a nitrogen gas flow. The magnetic behavior of the exchange-biased CoFeB/IrMn bilayer was studied to understand how the blocking temperature (T_B) is

affected by the following parameters: (i) the substrate (native vs. thermal oxide); (ii) the IrMn thickness (within the range 3.5-8 nm); (iii) the choice of the overlayer (MgO/Ru or Ru). The measurements were carried out by VSM adopting the same protocol for all the samples. First, they were kept for 20 minutes at $T = 550$ K. Then, a field-cooling (FC) down to 120 K was performed, with an in-plane magnetic field of 320 kA/m. Subsequently, the hysteresis loops at different increasing temperatures were measured to determine the temperature dependence of the exchange bias.

III. MAGNETIC CHARACTERIZATION

Fig. 1(b) reports the hysteresis loops measured after FC on a sample grown on Si/SiO₂, with $t_{\text{IrMn}} = 3.5$ nm and Ru capping layer ($t_{\text{Ru}} = 20$ nm). The hysteresis loop progressively shrinks (the coercive field H_C decreases) and shifts (the exchange bias field H_{EB} decreases) when T increases from 175 K (red curve, top) to 250 K (black curve, center) and 325 K (green curve, bottom).

The exchange bias is negative and the sample presents an in-plane uniaxial anisotropy along the FC direction, as expected. In fact, magnetization curves measured in the in-plane perpendicular direction do not show any exchange bias, whereas the out-of-plane direction is a hard magnetization axis due to shape anisotropy (data not shown). The CoFeB film does not acquire perpendicular magnetic anisotropy even for field-cooling of the AFM in the out-of-plane direction.

Two characteristic temperatures for the exchanged-biased system can be extracted from the complete trend versus temperature of H_C and H_{EB} , shown in Fig. 1(c). The first important temperature is the blocking temperature (T_B), corresponding to the zero of H_{EB} .

Secondly, looking at the coercive field behavior, we define T^* as the temperature above which H_C remains constant and is not affected by the presence of the antiferromagnet. According to [38], T^* can be assumed to be close to the characteristic Néel temperature (T_N) of the IrMn film, that is the temperature at which the AFM/paramagnetic transition occurs. For a CoFeB(3)/IrMn(3.5)/Ru(20) heterostructure, T_B and T^* result 343 ± 10 K and 393 ± 10 K, respectively.

FIG. 2 HERE

Fig. 2(a) reports the temperature trend of H_{EB} of four samples, with the same IrMn thickness ($t_{\text{IrMn}} = 6$ nm) and different capping layer, made by either Ru(20) or MgO(2.5)/Ru(20), and different substrate, standard Si(001) or Si(001) with ~1 μm of thermal SiO₂ on top (Si/SiO₂ from now on). As expected, due to the interposition of the Ta/Ru/Ta buffer layer between the substrate and the rest of the heterostructure, the resulting magnetic properties are relatively insensitive to the choice of standard Si(001) or Si/SiO₂. On the other hand, it is already evident that the choice of the capping layer (Ru or MgO/Ru) strongly influences the behavior and magnitude of the exchange bias versus temperature.

Fig. 2(b) reports the dependence of T_B and T^* on t_{IrMn} for Ru and MgO/Ru overlayers. The IrMn thickness ranges from 3.5 nm to 8 nm. When the IrMn layer is covered by Ru, both T_B and T^* can be measured down to the lowest IrMn investigated thickness (3.5 nm) and follow a trend similar to that observed on NiFe/IrMn bilayers by Van Driel et al. [39]. By contrast, the MgO overlayer inhibits the exchange bias of heterostructures with thin AFM layer ($t_{\text{IrMn}} < 6$ nm) within the investigated temperature range (100 K-500 K), so that T_B and T^* cannot be identified. Differently, for thicker IrMn ($t_{\text{IrMn}} \geq 6$ nm) the exchange bias is observed for both Ru and MgO/Ru overlayers, with the same value of T_B (see also Fig. 2(a)) and T^* , but a different magnitude of H_{EB} . Looking at Fig. 2(a), in this thickness range Ru capped samples present larger H_{EB} than MgO/Ru capped ones. Moreover, H_{EB} is anyway larger than H_C at RT ($H_{\text{EB}} = 15.04 \pm 0.24$ kA/m versus $H_C = 13.13 \pm 0.24$ kA/m for Ru capped samples, and $H_{\text{EB}} = 4.30 \pm 0.24$ kA/m versus $H_C = 1.59 \pm 0.24$ kA/m for MgO/Ru capped samples): this condition is fundamental for the pinning of the ferromagnetic layer as well as for magnetic patterning via local field-cooling.

IrMn layers thicker than 8 nm were not studied because the expected blocking temperature is higher than the temperature limit at which the heterostructure degrades when prepared by FC ($T_B = 550$ K, extrapolated from Fig. 2(b)). Indeed, we observed an irreversible reduction of both the CoFeB saturation magnetization and H_{EB} after annealing above 550 K, probably due to interdiffusion or oxidation.

IV. CHEMICAL CHARACTERIZATION

In this section, we present the study of IrMn composition as a function of IrMn thickness and overlayers, investigated by means of XPS to gain insight the presented magnetic behavior. The focus is what happens at the buried interface between IrMn and CoFeB from the chemical point of view, since the magnetic properties discussed above (coercive field, exchange bias field) depend on the exchange coupling between CoFeB and IrMn at their interface. To this aim, we studied the bunch of samples listed in Table 1, with different heterostructures (IrMn thickness, capping material) and post annealing treatments. The smallest thickness was 2.5 nm, smaller than 3.5 nm for the magnetic characterization: this is comparable with the electron inelastic mean free paths, aiming at highlighting interface effects.

TABLE 1 HERE

For each sample, core levels Mn 2p and Ir 4f peaks were acquired by XPS at RT and normal emission. The XPS intensity due to electrons from a core level P (Mn 2p or Ir 4f) is given by

$$I_P = \alpha T_P \sigma_P N_P \lambda_{P(\text{IrMn})} [1 - \exp(-t_{\text{IrMn}} / \lambda_{P(\text{IrMn})})] \exp(-t_C / \lambda_{P(\text{C})}) \quad (1)$$

α is a prefactor accounting for the experimental conditions (photon flux, incidence angle, etc.), T_P is the electron analyzer transmission at a given electron kinetic energy (KE), σ_P is the cross section, N_P is the layer atomic density, $\lambda_{P(\text{IrMn})}$ and $\lambda_{P(\text{C})}$ are the electron inelastic mean free paths in IrMn and in the capping layer (C) [40], t_{IrMn} and t_C are the IrMn and capping layer thickness, respectively. The Mn (Ir) content is finally calculated as $N_{\text{Mn}(\text{Ir})} / (N_{\text{Mn}} + N_{\text{Ir}})$, considering the atomic densities estimated by (1).

Note that the Mn and Ir contents depend, through (1), on the cross-sections and escape depths (in particular through the $\sigma_P \lambda_{P(\text{IrMn})}$ product) for photoelectrons of the core levels employed for quantification. Since the corresponding KE , to which these parameters are related [40], are quite different (~ 841 eV for Mn 2p_{3/2} versus ~ 1420 eV for Ir 4f), some discrepancies between the real and the estimated products could exist. To give a better estimation of N_{Mn} and N_{Ir} through (1), in the following we will instead assume for $\sigma_{\text{Mn}} \lambda_{\text{Mn}(\text{IrMn})}$ and $\sigma_{\text{Ir}} \lambda_{\text{Ir}(\text{IrMn})}$ the values leading to a nominal stoichiometry (Ir₂₂Mn₇₈) for sample U60 (see the Appendix), which represents the uncapped film used for the calibration of the sensitivity factors in XPS.

Equation (1) shows that the compositional information measured by XPS comes from a region of few escape depths $\lambda_{P(\text{IrMn})}$ (1.6 nm for Mn 2p and 2.0 nm for Ir 4f according to [40]), with a higher sensitivity to the topmost part of the IrMn film and a lower sensitivity to the buried IrMn/CoFeB interface. This means that, in the IrMn (2.5) samples, the overall intensity includes some contribution from the IrMn/CoFeB interface. For the IrMn (7) samples, instead, the thickness largely exceeds the escape depth and the buried interface is almost inaccessible to XPS investigation. Nevertheless, since the total amount of Mn atoms in a film is determined by its thickness and deposition parameters (pressure, Ar flow, temperature, rate), a Mn depletion (enrichment) at the topmost surface should correspond an enrichment (depletion) at the IrMn/CoFeB interface. Under this assumption, also a surface sensitive technique like XPS can be employed to qualitatively evaluate the Mn depth profile [41].

FIG. 3 HERE

We first consider sample R25, which presents the higher average Mn content. In Fig. 3(a) we report the XPS spectra of Mn 2p_{3/2} and Ir 4f, normalized to the peak areas, measured at normal emission ($\theta=0^\circ$, black dots) and grazing emission ($\theta=60^\circ$ from the sample normal, red empty dots). The latter, more sensitive to the surface, evidences a larger (smaller) Mn (Ir) content than the former, more bulk-sensitive, thus indicating the presence of a concentration gradient reducing (increasing) the Mn (Ir) content from top to bottom. This analysis shows the tendency of Mn diffusion towards the upper interface in samples capped with Ru, which must be associated to a partial Mn depletion at the CoFeB/IrMn

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interface. The same argument applies also to the other samples. In the following a relatively large average Mn content, as reported in Table 1, will be assumed as an indication of tendency to Mn diffusion towards the capping layer and, correspondingly, to partial depletion at the buried CoFeB/IrMn interface.

Starting from the thickest (7 nm) IrMn films [R70/R70a (Ru-capped) and M70/M70a (MgO/Ru-capped)] and considering $\pm 3\%$ accuracy, we found a slight depletion of Mn (4-6%) without any sizeable difference versus capping material (Ru vs. MgO/Ru) or post-growth annealing. This is coherent with the equivalent magnetic behavior (T_B , T^*) for $t_{\text{IrMn}} \geq 6$ nm shown in Fig. 2 [42]. This points to an intrinsic stability of the 7 nm thick IrMn layer. Samples with the thinnest IrMn layer (2.5 nm) [R25/R25a (Ru-capped) and M25/M25a (MgO/Ru-capped)] show instead a strong influence of the capping layer in determining the Mn and Ir content, as shown in Fig. 3(b). According to our discussion above, there is a sizable enrichment (depletion) of interfacial Mn at the topmost interface with Ru (MgO/Ru) capping. The annealing plays a marginal contribution.

FIG. 4 HERE

Beyond the concentration gradient, the XPS estimation of the Mn concentration could be affected by spurious effects: layers interface and surface roughness, intermixing and/or film oxidation, strain. In order to exclude any relevant role of roughness, we performed Atomic Force Microscopy (AFM) on Ru-capped samples. Fig. 4(a) reports the $10 \mu\text{m} \times 10 \mu\text{m}$ topographic image of the sample R70. The sample is atomically flat, with roughness of 0.3 nm (r.m.s.). The roughness of the sample with thinner IrMn layer (R25) is even lower (0.25 nm). These findings allow excluding any major role of the roughness, being small and independent on the IrMn thickness. Moreover, MgO grows layer by layer on flat IrMn surfaces (as previously demonstrated in [7] by some of the authors), so that it cannot be responsible of an increase of roughness. For what concerns intermixing and/or oxidation, Fig. 4(b) reports the Mn $2p_{3/2}$ peak acquired by XPS on the samples with 2.5 nm IrMn thickness (for which XPS probes the whole film), and for comparison on the uncapped IrMn sample (U60, see the Appendix). Apart from minor differences, the peak shape is the same, indicating that no relevant oxidation or intermixing takes place. Even if a minor role in determining the Mn content reported in Fig. 3(b) cannot be excluded for morphology, intermixing and/or oxidation, and strain, we can conclude that the concentration gradient remains the best candidate to explain such a huge variation (about 20% between M25 and R25). To summarize, we found that there is a one-to-one relationship between chemical (the upper Mn content) and magnetic (presence of exchange bias, critical temperatures) properties, with the exchange bias reinforced when Mn is pumped towards the uppermost interface. The 7 nm thick films share the same upper Mn content and all exhibit exchange bias, whereas the 2.5 nm thick films are strongly affected by the capping layer

in both the magnetic and chemical properties, with the exchange bias present (or absent) when the upper Mn content is larger (smaller) with Ru (MgO/Ru) capping.

The Mn pumping towards Ru in thinner films can be ascribed to the formation of a Mn-Ru alloy [43]. A possible scenario is the following: when Ru is grown directly on IrMn, the thermal energy released by the sputtered Ru atoms could activate this reaction, resulting in a tendency of Mn atoms to be absorbed by, or be close to, the Ru layer. Because Ir atoms are not affected by this process, XPS finds a global increase of the upper Mn content. When MgO is placed between Ru and MgO, this effect is instead inhibited. A more detailed investigation of such mechanisms is anyway beyond the scope of this paper.

A qualitative explanation for the relationship between chemical (the upper Mn content) and magnetic properties could be found in [35], where a direct proportionality between the Ir content and the exchange bias field of a IrMn/CoFe bilayer is reported [44]. Considering the samples with 2.5 nm IrMn thickness, the Ru-capped ones (R25 and R25a) present a negative (positive) Mn (Ir) gradient (see Fig. 3(a)) from top to bottom, whereas for the MgO/Ru-capped ones (M25 and M25a) the trend is opposite. Following [35], the exchange bias field is predicted to be larger for Ru-capped samples, because the Ir content at the interface with the ferromagnet is larger too, than for MgO/Ru-capped ones. This behavior reflects our experimental data, with the exchange bias well noticeable for Ru-capped samples and below the experimental accuracy in MgO/Ru-capped ones.

We can conclude that Ru plays an active role in preserving the exchange bias, even at very low IrMn thickness, by pumping Mn, and thus leaving the IrMn/CoFeB interface Ir-rich. This effect is inhibited when a MgO interlayer is placed between Ru and IrMn, and thus the exchange bias disappears. Note that this behavior, that takes place below 6 nm IrMn thickness in MgO/Ru-capped samples, could be likely ascribed to the decrease of the blocking temperature below the minimum temperature our system can reach (100 K). At larger thickness, the IrMn/CoFeB interface is no longer influenced by the overlayer and the magnetic behavior becomes independent on it, exhibiting exchange bias both on Ru and MgO/Ru capped samples.

V. CONCLUSION

In conclusion, we reported on the magnetic (VSM) and chemical (XPS) characterization of CoFeB/IrMn bilayers, grown by magnetron sputtering on a suitable template (Ta/Ru/Ta), with different IrMn thickness and capping material (Ru vs. MgO/Ru). The use of Si/native-SiO₂ or Si/thermal-SiO₂(1 μm) substrates does not influence the magnetic properties of the IrMn/CoFeB bilayer, probably thanks to the buffer template Ta/Ru/Ta. The critical

temperatures (the blocking temperature and T^*) increase vs. the IrMn thickness but, whereas for Ru capping this is true in the whole thickness range we investigated (3.5-8 nm), for MgO/Ru capping exchange bias is inhibited below 6 nm, whereas from 6 nm the behavior is the same of Ru-capped films. The Mn content depends even on the capping layer (the Mn content close to the interface with CoFeB is smaller (larger) than the bulk-like situation for Ru (MgO/Ru) capping) in thin films (2.5 nm), whereas is independent in thicker films (7 nm). Our work suggests that a non-uniform composition of the IrMn films directly affects the exchange coupling at the IrMn/CoFeB interface.

Table 1. List of the samples investigated by XPS. The capital letter refers to the capping material (U= uncapped, R= Ru, M= MgO), the number is the IrMn thickness in Angstrom, and the final letter (a), if present, indicates that the sample has been annealed. The Mn content is calculated as $N_{Mn}/(N_{Mn} + N_{Ir})$, where N_{Mn} and N_{Ir} are the Mn and Ir atomic densities estimated by (1).

Sample label	IrMn thickness	IrMn overlayer	Post-growth annealing	Mn content
U60	6 nm	none	no	78%
R25	2.5 nm	Ru	no	92%
R25a	2.5 nm	Ru	523 K	95%
R70	7 nm	Ru	no	72%
R70a	7 nm	Ru	523 K	73%
M25	2.5 nm	MgO/Ru	no	65%
M25a	2.5 nm	MgO/Ru	523 K	68%
M70	7 nm	MgO/Ru	no	74%
M70a	7 nm	MgO/Ru	523 K	74%

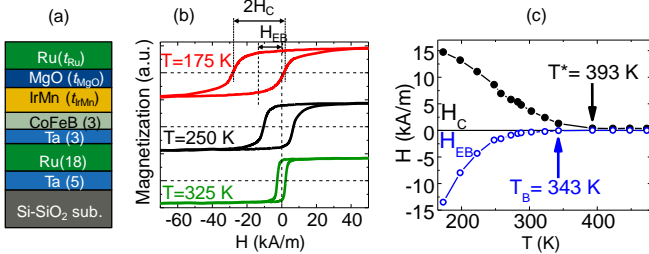


Fig. 1. (a) sketch of the heterostructure; (b) hysteresis loops of a Si/SiO₂/Ta(5)/Ru(18)/Ta(3)/CoFeB(3)/IrMn(3.5)/Ru(20) heterostructure after field-cooling; (c) temperature dependence of the coercive field (H_C) and the exchange bias field (H_{EB}). T^* and T_B are defined as the temperatures at which H_C (black curve, top) and H_{EB} (blue curve, bottom), respectively, approach to asymptotical values (zero in the case of H_{EB}).

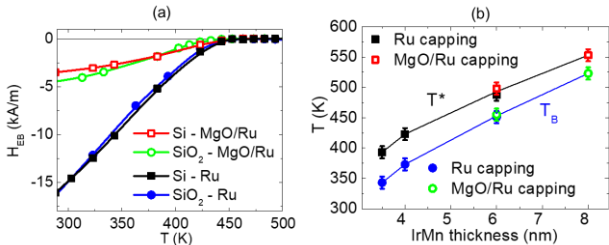


Fig. 2. (a) Exchange bias field (H_{EB}) as a function of the temperature for samples with $t_{IrMn} = 6$ nm, grown on either Si or Si/SiO₂ substrates, with Ru or MgO/Ru capping; (b) blocking temperature (T_B) and T^* as a function of the IrMn thickness for different overlayers (MgO/Ru or Ru).

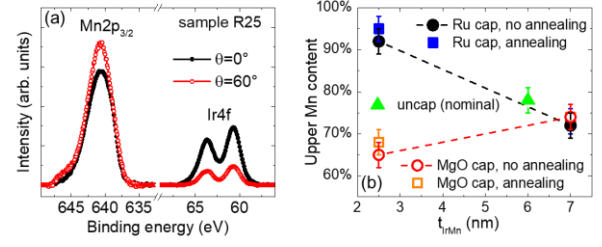


Fig. 3. (a) XPS spectra on Mn $2p_{3/2}$ and Ir 4f core levels on sample R25 at normal ($\theta = 0^\circ$, black dots) and grazing ($\theta = 60^\circ$, red empty dots) emission, evidencing a Mn surface segregation; (b) Mn content measured by XPS vs. IrMn thickness, evaluated by XPS measuring Mn $2p_{3/2}$ and Ir 4f peaks, for the samples reported in Table 1. The dashed lines are only guides for the eye.

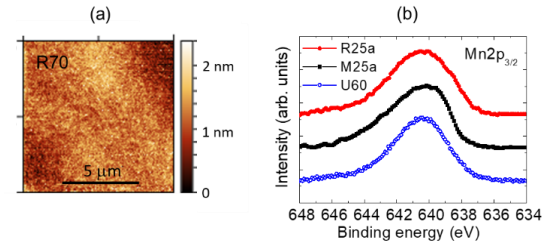


Fig. 4. (a) AFM of R70 sample, $10 \mu\text{m} \times 10 \mu\text{m}$ area. The roughness r.m.s. is 0.3 nm. (b) XPS spectra on Mn $2p_{3/2}$ core level on samples R25, R70, and U60 at normal emission.

APPENDIX

A. Chemical characterization of IrMn uncapped films

Two uncapped IrMn films, with $t_{IrMn} = 6$ nm (sample U60) and $t_{IrMn} = 20$ nm (sample U200) respectively, were used as reference for XPS characterization of the IrMn films discussed in the paper (see Table 1). The base template was Si(001)/thermal-SiO₂(1 μm)/Ta(5 nm)/Ru(18 nm)/Ta(3 nm). Mn 3p, Mn 2p, Ir 4f and O 1s peaks were acquired by XPS at room temperature and normal incidence employing Al-K α and Mg-K α sources. The corresponding electron escape depths are well below t_{IrMn} for both the samples [40]: any spurious contribution due to the interface with the bottom layer (CoFeB) can thus be excluded in the IrMn analysis.

Looking at the stoichiometry, the relative concentrations of Ir and Mn were initially measured by acquiring Mn 3p and Ir 4f peaks with Al-K α source. We choose these peaks because of the small difference in the photoelectron kinetic energies (KE), and thus in the corresponding electron escape depths, meaning the IrMn region probed by XPS is almost the same. The photoelectron intensity from the peak P (Mn 3p or Ir 4f) is given by:

$$I_P = \alpha T_P \sigma_P N_P \lambda_P [1 - \exp(-t_{IrMn} / \lambda_P)] \quad (1A)$$

α is a prefactor accounting for experimental conditions (photon flux, incidence angle, etc.), T_P is the electron analyzer transmission, σ_P is the atomic cross section, N_P is the atomic

density, λ_P is the escape depth, and t_{IrMn} is the IrMn film thickness. The Mn [Ir] content has been calculated as $N_{\text{Mn}}/(N_{\text{Mn}}+N_{\text{Ir}})$ [$N_{\text{Ir}}/(N_{\text{Mn}}+N_{\text{Ir}})$], and resulted 79% [21%] for sample U60 and 78% [22%] for sample U200. Within the experimental accuracy ($\pm 3\%$), the two samples appear identical and coherent with the target composition ($\text{Ir}_{22}\text{Mn}_{78}$).

FIG. 1A HERE

In Fig. (1A) we report the Mn 2p and O 1s peaks from sample U60 at room temperature, measured by Al- K_{α} and Mg- K_{α} sources, respectively, after subtracting an integral background due to secondary electrons. Mn 2p_{3/2} in panel (a) presents a shoulder, with binding energy 5.7 eV larger than the main peak one. Following [45], this can be ascribed to a Mn oxidation state with +2 valence, possibly due to oxygen coming from air exposure during the transfer from growth to measurement chambers. The presence of the oxygen is also confirmed by the O 1s spectrum, reported in panel (b). In this case, two contributions can be clearly distinguished: a larger one at higher binding energy (dashed red line) and a smaller one at lower binding energy (dashed-dotted blue line). If sample is tilted by 60° with respect to the normal (in order to increase the surface sensitivity), the former increases and the latter decreases. This allows us to ascribe the first contribution, centered at 532 eV, to atomic oxygen lying on the IrMn surface and thus evidenced at grazing incidence, and the second, centered at 529.8 eV, to oxygen bonded with Mn inside the film [46]. The ratio between the areas of the film and surface components ($R_{F/S}$) decreases from 0.8 at normal incidence to 0.4 at grazing incidence (60° from the normal, data not shown). We note that, despite the peak and shoulder positions suggest a +2 Mn oxidation state [45], other situations cannot be excluded. Actually, tabulated shapes and positions do not strictly apply to our case, because they come from Mn oxides and hydroxides, whereas the Ir contribution could play a role in determining position and shape of the core lines.

At variance with Mn, Ir 4f does not show any oxidation feature. This can be explained on the basis of the enthalpy of formation of the respective compounds [47]: because all Mn oxides are energetically favourable with respect to Ir oxides [48], oxygen embedded in the IrMn matrix will preferably bind to Mn, leaving Ir not oxidized.

Finally, the effect of an annealing at 523 K for 30 minutes has been evaluated. This is a typical procedure employed in IrMn-based devices for setting exchange bias properties by a field-cooling procedure. The stoichiometry of both samples is unaffected by this procedure (Mn content increases of 1%, smaller than the $\pm 3\%$ accuracy). The ratio $R_{F/S}$ instead more than doubles after annealing, probably because of thermal desorption of surface oxygen. Anyway, peak positions of both film and surface components do not change, indicating that there is no chemical modification of the structure.

Finally, it is worthwhile to note that, if we employ Mn 2p instead of Mn 3p for Mn quantification (as in the paper), an apparent Mn-deficiency appears, with 69% Mn concentration

instead of 78% ($\text{Ir}_{31}\text{Mn}_{69}$ instead of $\text{Ir}_{22}\text{Mn}_{78}$). This can be due to an incorrect estimation of the Mn 2p electron escape depth (we assumed 1.6 nm following [40], coherently with the other peaks): as a matter of fact, over(under)estimation of this parameter would predict a smaller (larger) Mn content. The better reliability of Mn 3p, as proved by the coherency with the nominal target stoichiometry, can be ascribed to the proximity of Mn 3p and Ir 4f peaks (the binding energies are 48 eV and 61-64 eV, respectively, whereas Mn 2p_{3/2} is at 641 eV), resulting in electron escape depths more similar, and thus almost identical probed depths. Unfortunately, Mn 3p cannot be used in Ru and MgO/Ru capped samples, because of the superposition with the Ru 4p peak: then, in the analysis reported in the paper we have been forced to use Mn 2p and employ a normalization procedure in order to evaluate the real stoichiometry.

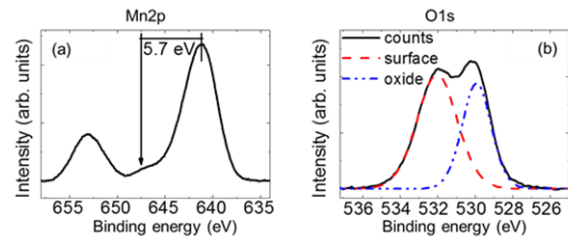


Fig. 1A. (a) Mn 2p and (b) O 1s features from sample B at room temperature, measured by Al- K_{α} and Mg- K_{α} sources respectively, after subtracting an integral background due to secondary electrons.

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